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Bjørn F. Andresen
Gabor F. Fulop
Charles M. Hanson
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Lucy Zheng, Institute for Defense Analyses (United States)
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Session Chairs

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Tonny Benschop, Thales Cryogenics B.V. (Netherlands)
Alexander Veprik, CRYO TECH Ltd., Gevasol (Israel)

- 2 Cryogenic Cooling of Sensing Devices 2019: Cooler Applications
Tonny Benschop, Thales Cryogenics B.V. (Netherlands)
Alexander Veprik, CRYO TECH Ltd., Gevasol (Israel)

- 3 T2SL I
Meimei Z. Tidrow, U.S. Army Night Vision & Electronic Sensors Directorate (United States)
Lucy Zheng, Institute for Defense Analyses (United States)
Manijeh Razeghi, Northwestern University (United States)

- 4 Conference Keynote
Bjørn F. Andresen, Consultant, Infrared Technologies & Applications (Israel)

- 5 T2SL II
Meimei Z. Tidrow, U.S. Army Night Vision & Electronic Sensors Directorate (United States)
Lucy Zheng, Institute for Defense Analyses (United States)
Linda Höglund, IRnova AB (Sweden)

- 6 HOT I
Michael T. Eismann, Air Force Research Laboratory (United States)
Sanjay Krishna, The Ohio State University (United States)

- 7 A Word from the Master
Gabor F. Fulop, Maxtech International, Inc. (United States) and Infrared Imaging News (United States)

- 8 HOT II
Michael T. Eismann, Air Force Research Laboratory (United States)
Sanjay Krishna, The Ohio State University (United States)

- 9 NIR / SWIR
John Liobe, Sensors Unlimited, a United Technologies Company (United States)
Martin H. Ettenberg, Princeton Infrared Technologies, Inc. (United States)

- 10 HgCdTe
Whitney Mason, DARPA (United States)
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John Lester Miller, Cascade Electro-Optics, LLC (United States)
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